

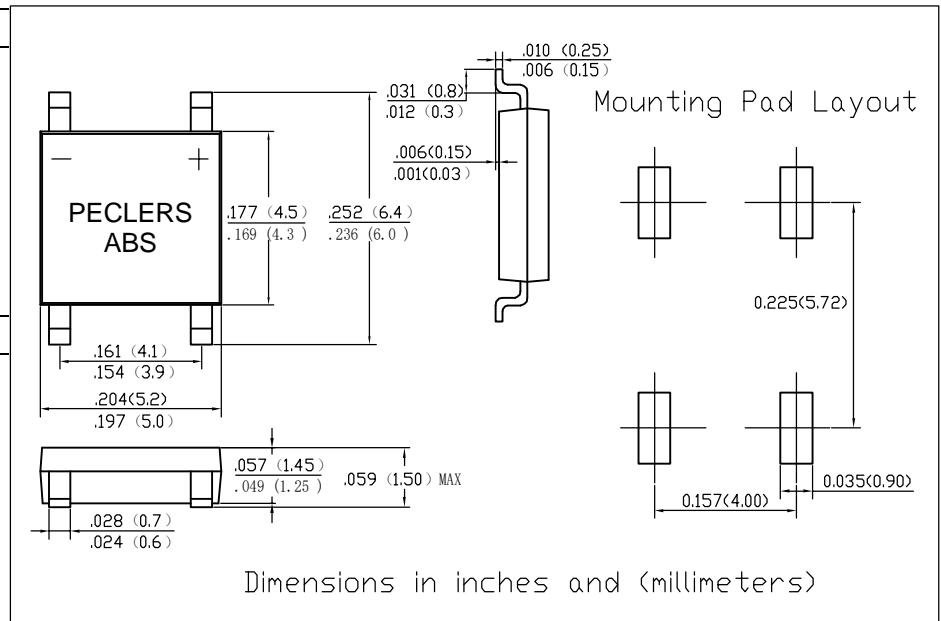
REVERSE VOLTAGE: 50 to 1000 VOLTS
FORWARD CURRENT: 1.0 AMPERE

FEATURES

- Surge overload rating: 35 amperes peak
- Ideal for printed circuit board
- Plastic material has Underwriters Laboratory Flammability Classification 94V-0
- Low leakage
- Reliable low cost construction utilizing molded

MECHANICAL DATA

Case: Molded plastic, ABS
 Epoxy: UL 94V-0 rate flame retardant
 Terminals: Leads solderable per MIL-STD-202, method 208 guaranteed
 Mounting position: Any



Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.
 Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

	Symbols	ABS05	ABS1	ABS2	ABS4	ABS6	ABS8	ABS10	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current (see Fig. 1) on glass-epoxy P.C.B (Note 2) on aluminum substrate (Note 3)	$I_{(AV)}$	0.8							Amp
		1.0							
Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	35							Amp
Maximum Forward Voltage at 1.0A DC and 25°C	V_F	1.10							Volts
Maximum Reverse Current at Rated DC Blocking Voltage	I_R	5.0							uAmp
		150							
Typical Junction Capacitance (Note 1)	C_J	13							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	80							°C/W
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	62.5							°C/W
Operating and Storage Temperature Range	T_J, T_{stg}	-55 to +150							°C

NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
- 3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad

RATINGS AND CHARACTERISTIC CURVES

